MX23C4000

4M-BIT MASK ROM (8 BIT OUTPUT)

FEATURES

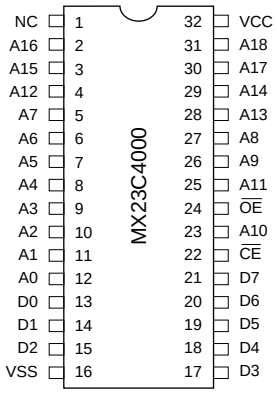
- Bit organization
  - 512K x 8 (byte mode)
- Fast access time
  - Random access: 90ns (max.)
- Current
  - Operating: 35mA
  - Standby: 100mA
- Supply voltage
  - 5V ± 10%
- Package
  - 32 pin PDIP (600 mil)
  - 32 pin PLCC
  - 32 pin SOP (450 mil)
  - 32 pin TSOP (8mm x 20mm)

ORDER INFORMATION

Part No.	Access Time	Package
MX23C4000PC-10	100ns	32 pin PDIP
MX23C4000PC-12	120ns	32 pin PDIP
MX23C4000PC-15	150ns	32 pin PDIP
MX23C4000QC-10	100ns	32 pin PLCC
MX23C4000QC-12	120ns	32 pin PLCC
MX23C4000QC-15	150ns	32 pin PLCC
MX23C4000MC-90	90ns	32 pin SOP
MX23C4000MC-10	100ns	32 pin SOP
MX23C4000MC-12	120ns	32 pin SOP
MX23C4000MC-15	150ns	32 pin SOP
MX23C4000TC-10	100ns	32 pin TSOP
MX23C4000TC-12	120ns	32 pin TSOP
MX23C4000TC-15	150ns	32 pin TSOP

PIN CONFIGURATION

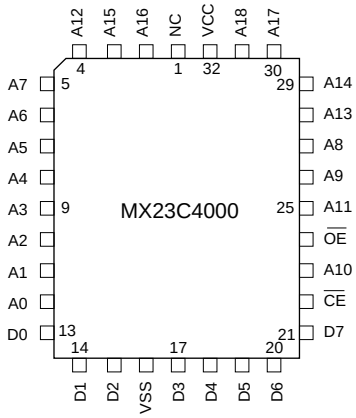
32 PDIP / 32 SOP



PIN DESCRIPTION

Symbol	Pin Function
A0~A18	Address Inputs
D0~D7	Data Outputs
$\overline{CE}$	Chip Enable Input
$\overline{OE}$	Output Enable Input
VCC	Power Supply Pin
VSS	Ground Pin
NC	No Connection

32 PLCC



32 TSOP

ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Ratings
Power Supply Voltage	VCC	-0.5V to 7.0V
Input Voltage	VI	-0.5V to VCC + 0.5V
Output Voltage	VO	-0.5V to VCC + 0.5V
Ambient Operating Temperature	Topr	-10°C to 70°C
Storage Temperature	Tstg	-65°C to 125°C

DC CHARACTERISTICS (Ta = -10° C ~ 70° C, VCC = 5.0V ± 10%)

Item	Symbol	MIN.	MAX.	Conditions
Output High Voltage	VOH	0.8VCC	-	IOH = -100mA
Output Low Voltage	VOL	-	0.4V	IOL = 2.1mA
Input High Voltage	VIH	2.2V	VCC+0.5V	
Input Low Voltage	VIL	-0.3V	0.8V	
Input Leakage Current	ILI	-	5mA	0V, VCC
Output Leakage Current	ILO	-	5mA	0V, VCC
Operating Current	ICC1	-	35mA	tRC = 100ns, all output open
Standby Current (TTL)	ISTB1	-	1mA	$\overline{CE}$ = VIH
Standby Current (CMOS)	ISTB2	-	100mA	$\overline{CE}$ > VCC - 0.2V
Input Capacitance	CIN	-	10pF	Ta = 25°C, f = 1MHz
Output Capacitance	COUT	-	10pF	Ta = 25°C, f = 1MHz

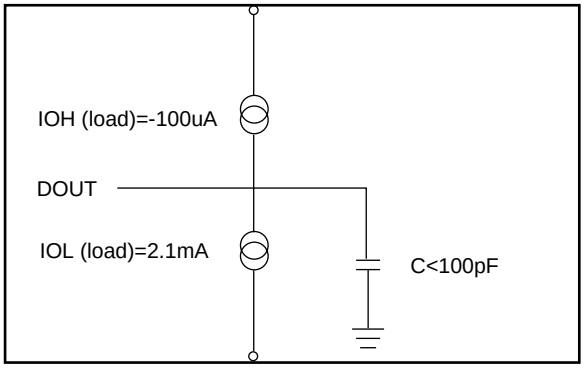
AC CHARACTERISTICS (Ta = -10°C ~ 70°C, VCC = 5.0V ± 10%)

Item	Symbol	23C4000-90		23C4000-10		23C4000-12		23C4000-15	
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
Read Cycle Time	tRC	90ns	-	100ns	-	120ns	-	150ns	-
Address Access Time	tAA	-	90ns	-	100ns	-	120ns	-	150ns
Chip Enable Access Time	tACE	-	90ns	-	100ns	-	120ns	-	150ns
Output Enable Time	tOE	-	45ns	-	50ns	-	60ns	-	70ns
Output Hold After Address	tOH	0ns	-	0ns	-	0ns	-	0ns	-
Output High Z Delay	tHZ	-	20ns	-	20ns	-	20ns	-	20ns

Note : Output high-impedance delay (tHZ) is measured from $\overline{OE}$ or $\overline{CE}$ going high, and this parameter guaranteed by design over the full voltage and temperature operating range - not tested.

AC Test Conditions

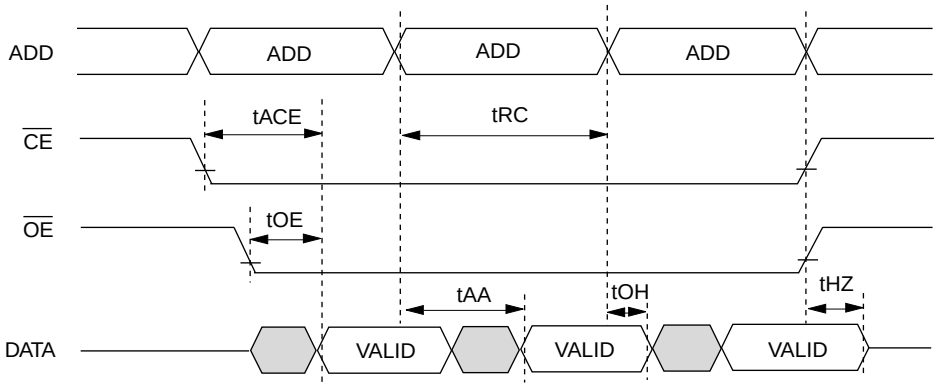
- Input Pulse Levels : 0.4V~2.4V
- Input Rise and Fall Times : 10ns
- Input Timing Level : 1.5V
- Output Timing Level : 0.8V and 2.0V
- Output Load : See Figure



Note:No output loading is present in tester load board.
Active loading is used and under software programming control.
Output loading capacitance includes load board's and all stray capacitance.

TIMING DIAGRAM

RANDOM READ



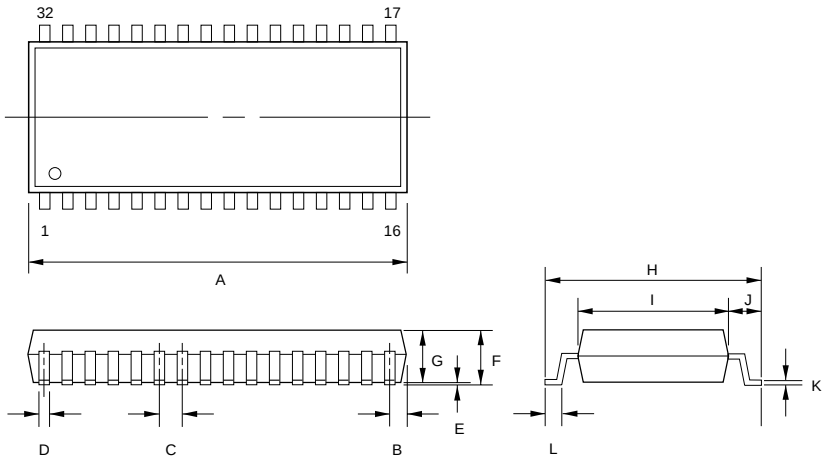
Note: $\overline{CE}$,$\overline{OE}$ are enable

PACKAGE INFORMATION

32-PIN PLASTIC SOP (450 mil)

ITEM	MILLIMETERS	INCHES
A	20.95 max.	.825 max.
B	1.00 [REF]	.039 [REF]
C	1.27 [TP]	.050 [TP]
D	.40 [Typ.]	.016 [Typ.]
E	.05 min.	.002 min.
F	3.05 max.	.120 max.
G	2.69±13	.106±005
H	14.12±25	.556±010
I	11.30±13	.445±005
J	1.42	.056
K	.20 [Typ.]	.008 [Typ.]
L	.79	.031

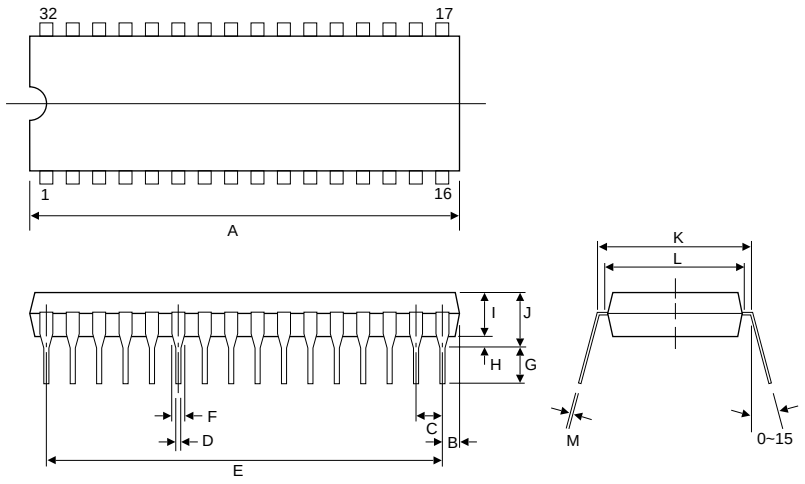
NOTE: Each lead centerline is located within .25 mm[.01 inch] of its true position [TP] at maximum material condition.



32-PIN PLASTIC DIP (600 mil)

ITEM	MILLIMETERS	INCHES
A	42.13 max.	1.660 max.
B	1.90 [REF]	.075 [REF]
C	2.54 [TP]	.100 [TP]
D	.46 [Typ.]	.018 [Typ.]
E	38.07	1.500
F	1.27 [Typ.]	.050 [Typ.]
G	3.30±25	.130±010
H	.51 [REF]	.020 [REF]
I	3.94±25	.155±010
J	5.33 max.	.210 max.
K	15.22±25	.600±010
L	13.97±25	.550±010
M	.25 [Typ.]	.010 [Typ.]

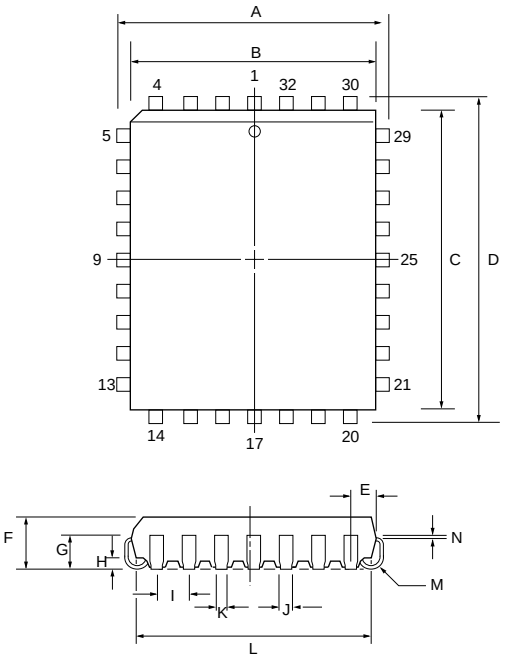
NOTE: Each lead centerline is located within .25 mm[.01 inch] of its true position [TP] at maximum material condition.



32-PIN PLASTIC LEADED CHIP CHARRIER (PLCC)

ITEM	MILLIMETERS	INCHES
A	12.44±13	.490±005
B	11.50±13	.453±005
C	14.04±13	.553±13
D	14.98±13	.590±13
E	1.93	.076
F	3.30±25	.130±010
G	2.03±13	.080±005
H	.51±13	.020±005
I	1.27 [Typ.]	.050 [Typ.]
J	.71 [REF]	.028 [REF]
K	.46 [REF]	.018 [REF]
L	10.40/12.94	.410/.510
	(W) (L)	(W) (L)
M	.89 R	.035 R
N	.25 [TYP.]	.010 [TYP.]

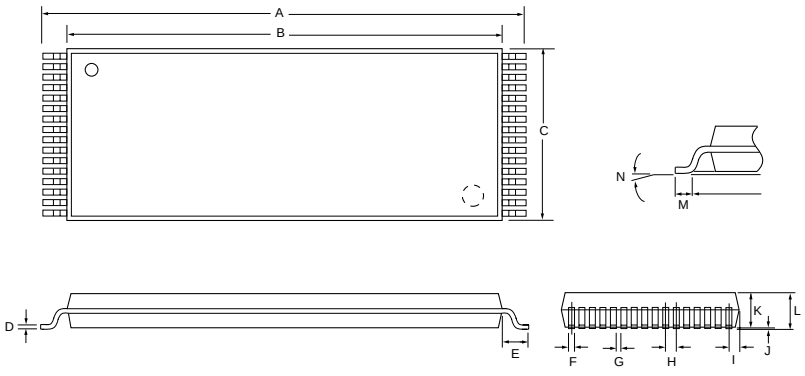
NOTE: Each lead centerline is located within .25 mm[.01 inch] of its true position [TP] at maximum material condition.



32-PIN PLASTIC TSOP

ITEM	MILLIMETERS	INCHES
A	20.0±20	.078±006
B	18.40±10	.724±004
C	8.20 max.	.323 max.
D	.15 [Typ.]	.006 [Typ.]
E	.80 [Typ.]	.031 [Typ.]
F	.20±10	.008±004
G	.30±10	.012±004
H	.50 [Typ.]	.020 [Typ.]
I	.45 max.	.018 max.
J	0 ~ .20	0 ~ .008
K	1.00±10	.039±004
L	1.27 max.	.050 max.
M	.50	.020
N	0 ~ 5°	.500

NOTE: Each lead centerline is located within .25 mm[.01 inch] of its true position [TP] at maximum material condition.



REVISION HISTORY

REVISION	DESCRIPTION	PAGE	DATE
3.7	AC Characteristics: tOH 10ns --> 0ns	P3	JAN/29/1999

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